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Applicant(s) OKADA	
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[illegible][illegible]

9/18		Bhusari, et al. "Fabrication of Air-Gaps Between Cu Interconnects for Low Intralevel k" D4. 8 MRS symposium proceedings Vol. 612, 2000.

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.